

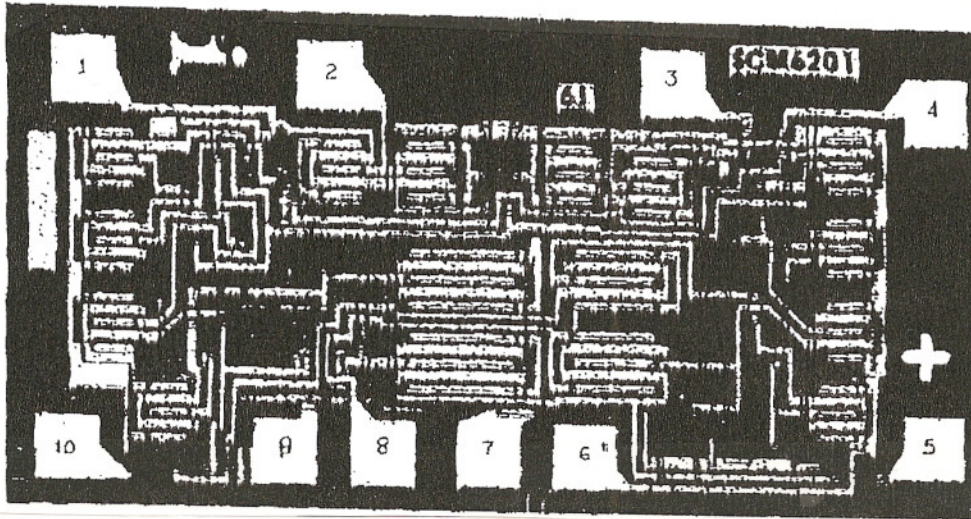


# Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.

INERSIL CHIP SIZE: 75 X 69 MILS



<u>PAD NO.</u>	<u>FUNCTION</u>	<u>PAD NO.</u>	<u>FUNCTION</u>
1	02	6	V-
2	02	7	GND
3	01	8	VL = +5V
4	01	9	V+
5	IN1	10	IN2

**Topside Metal: Al**  
**Backside: Si**  
**Backside Potential:**  
**Mask Ref: Issue 1**  
**Bond Pads : .004"**

**APPROVED BY: CB**  
**MFG: IDT**

**DIE SIZE : .035" x .069"**  
**THICKNESS: .020"**

**DATE: 2/7/01**  
**P/N: Ih6201**

DG 10.1.2  
 Rev A 3-4-99